MSPP







Main Features

- State-of-the-art multi-service platform supporting STM-1/STM-4/STM-16 aggregation
- High-density design with 1U height
- Huge cross-connection matrix capacity:
 - ✓ STM-1 Uplink: 20*20 VC4 (high order cross-connection) or 1260*1260 VC12 (full cross-connection)
 - ✓ STM-4 Uplink: 32*32 VC4 (high order cross-connection) or 1260*1260 VC12 (full cross-connection)
 - ✓ STM-16 Uplink: 96*96 VC4 (high order cross-connection) or 2016*2016 VC12 (full cross-connection)
- Reliable protection APS; SNCP; MS-SPRING; MSP protection
- Rich topologies star, ring, linear, mesh and so on
- Easy Management friendly GUI management; divided into several module: warning, log, performance, configuration, database backup and recovery, etc., support online upgrading
- Various services- E1, V.35, Fast Ethernet (electrical or optical), Giga Ethernet; STM-1 and STM-4 tributaries;
- Flexible: configured to a certain number of aggregation and tributary with varying link capacities, all modular cards are hot-swappable and plug-and-play
- Ethernet: EoS or EoPDH
- Implement seamless connection with MAN; easy to maintenance, save investment
- Power redundancy

Overview

MSPP is a high-density aggregation device which provides a highly cost-effective and simple solution based on STM-1/STM-4/STM-16 network to transport multiple E1, V.35 and Ethernet over existing SDH networks. Installed at the customer site or directly on STM-1 access rings, MSPP leverages the SDH infrastructure for internet access and LAN connectivity, while providing continued support for E1/V.35 services. MSPP has internal cross connect capabilities that enable it to support a wide range of applications. When deployed in a ring application, the MSPP provides a complete path protection mechanism that prevents any service failure, even if a fiber link is damaged or disconnected.

Reduce Cost Increase Revenue

Multiservice modules in one box, save space and the expense of implementation. MSPP integrates Ethernet featured packet switch network which is built on directly over legacy SDH network without extra expenditure.

Multiservice Providing

MSPP connects LAN traffic with increments of 2 Mbps over existing SDH networks.

In addition to Ethernet service, MSPP continues to integrate traditional E1 and V.35 interfaces for PSTN and DDN networks.

Safe and Sound Protection

Protection is very important for the high aggregated device. Our MSPP provide full protection: SNCP for E1 and V.35 path, MSP for Ring application, APS for optical link protection in point to point application.

Moreover, The Ethernet adopts GFP/LCAS/VCAT

mechanism by bounding amounts of VC12 in separate STM-1 links, thus when one link is down, the mechanism can dynamically adjust the bandwidth by deleting the fault VC12 without terminating service.

High Capacity and Modular Design

Aggregation: 2*STM-1 or 2*STM-4 or 2*STM-16

Tributaries: 8*STM-1 or 8*STM-4 or 96*E1 or 4*E3/DS3 or 16*FE or 4*GE or 28*V.35

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	STM-1 Interface		100Base-Fx Interface	
-	STM-1 optical signal as per ITU-T G.957, G.958	-	Interface: 100Base-FX	
-	Data rate: 155.52 Mbps	-	Interface protocol: : compliant with IEEE802.3u	
-	Line code: 1B1H	-	Line rate: 100Mbit/s	
-	Optical fiber: single mode, multimode	-	Optical fiber: single mode	
-	Dual strand or single strand bi-directional	-	Connector: FC/SC10/100/1000Base-Tx	
-	Interface: S-1.1, S1.2, L-1.1, L-1.2		10/100/1000Base-Tx Interface	
-	Connector: FC or SC	-	Interface: 10/100/1000BASE-T	
	SMT-4 Interface	-	Interface protocol: compliant with IEEE 802.3u, IEEE	
-	Data Rate: 622.08Mbps		802.3ab, IEEE 802.1q, IEEE 802.3x	
-	Refer to SFP module specification.	-	Data rate: 10/100/1000Mbps speed mode selectable	
	STM-16 Interface		(auto-negotiation or force mode)	
-	Data Rate: 2488.32Mbps	-	Duplex mode: full duplex or half duplex	
-	Refer to SFP module specification.	-	Interface line sequence: MDI/MDI-X auto-sense	
	E1 Interface	-	Connector: RJ-45	
-	Standard: ITU-T G.703		1000Base-Fx Interface	
-	Framing: unframed	-	Interface: 1000Base-FX	
-	Line rate: 2048kbps ± 50ppm	-	Interface Protocol: comply with IEEE-802.3, IEEE-802.3z	
-	Line Code: HDB3	-	Data rate: 1000Mbps auto-negotiation, full-duplex	
-	Line Impedance: 750hm or 1200hm optional	-	Connector: SC/FC	
-	Electrical Characteristic: comply with ITU-T G.703		Management Interface	
-	Jitter Performance: comply with ITU-TG.823	Con	sole Interface	
-	Connector: RJ45 (Each RJ45 supports 2*E1)	-	Interface: RS-232 serial port	
	V.35 Interface	-	Baud rate: 115200bps	
-	Interface protocol: compliant with ITU-T V.35	-	Connector: RJ-45	
-	Interface rate: framed N×64Kbit/s (N=1~31), unframed		General	
	2048Kbit/s	-	Power Supply: AC 220VAC; DC -48VDC (Redundancy)	
-	Work mode: DCE or DTE optional	-	Power Consumption ≤ 100W	
-	Connector: DB25 female	-	Dimension (W×D×H): 440x240x136 mm	
	10/100Base-Tx Interface	-	Working Environment	
-	Interface: 4×10/100Base-TX		Temperature: 0°C~50°C·	
-	Interface protocol: compliant with		Humidity: Up to 90% non-condensing	
-	IEEE802.3u, IEEE802.3x, IEEE802.3p			
-	Data rate: 10/100Mbps auto-negotiation or force mode			
-	Work mode: full duplex, half duplex			
-	Connector: RJ-45, CAT5/6 UTP			
-	Interface line sequence: MDI/MDI-X auto-sense			
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ORDERING INFORMATION

CHASSIS

011/0010								
MSPP-CHAS	MSPP-CHAS 19", 1U, with 2 Power Slots, 1 Network Management Slot, 1 Aggregation Service Slots, 4 Tributary Servi							
POWER MODULA	R CARD							
MSPP-AC1	MSPP-AC1 110V AC; Support 1+1 Redundancy							
MSPP-AC2	ISPP-AC2 220V AC; Support 1+1 Redundancy							
MSPP-DC	ASPP-DC -48V DC; Support 1+1 Redundancy							
MANAGEMENT MODULAR CARD								
MSPP-NM	P-NM 2*RJ45 Management Ethernet Ports, Support Online Upgrading							
AGGREGATION MODULAR CARD								
AG-STM1	2*STM-1 SC Interface	AG-STM4S	2*STM-16 SFP Interface					
AG-STM1S	2*STM-4 SFP Interface	AG-STM16S	2*Electrical STM-1 Interface					
TRIBUTARY MODU	JLAR CARD	_						
TR-STM1/TR-STM1S	2*STM-1 SC/SFP Interface	TR-2FEAG	2*10/100Base-Tx; EoS, Ratio: 8:2, GFP/LCAS/ VCAT					
TR-STM1E	2*STM-1 Electrical	TR-GEAG	1*10/100/1000Base-Tx; EoS, Ratio 8:1					
TR-2STM1/2FE	2*STM-1 +2*10/100Base-Tx	TR-GXAG	1*Combo GE (1*10/100/1000Base-Tx and 1*SFP);					
TR-2STM1/2FEA	2*STM-1+2*10/100Base-Tx (isolated ports)		EOS, Ratio 8:1					
TR-STMFE	1*STM-1 SFP +1*10/100Base-Tx	TR-2FEAGP	2*10/100Base-Tx; EoPDH or EoE; Ratio 8:2					
TR-STM4	2*STM-4	TR-GEAGP	1*10/100/1000Base-Tx; EoPDH or EoE; Ratio 8:1					
TR-24EB	24*E1; 120ohm; Occupy 2 slots RJ45 (2*E1 for each RJ45)	TR-DS0	Full 64E1 DS0 Cross connection, Matrix: 2048*2048					
TR-24EU	24*E1; 75ohm; Occupy 2 slots; RJ45 (2*E1/RJ45); Should order Cable separately	TR-V35	2*V35; DTE/DCE; Should order BH4.851.103 DCE Cable separately					
TR-12EU	12*E1; 75ohm; RJ45 (2*E1/RJ45) Should	TR-DS0	Full 64E1 DS0 Cross connection. Matrix:					
	order Cable separately		2048*2048					
TR-12EB	12*E1; 120ohm; RJ45 (2*E1/RJ45)	TR-E3	1*E3; CC4 Interface Type					
TR-4FE	4*10/100Base-Tx; EoS, GFP/LCAS/VCAT	TR-OW	1*OW+1*External Clock Input&Output +1*RS232					
TR-4FX	4*100Base-Fx; SFP; EoS, GFP/LCAS/VCAT		Asynchronous Interface					